

STD60NF55LAT4

Automotive-grade N-channel 55 V, 12 mΩ typ., 60 A STripFET™ II Power MOSFET in a DPAK package

Datasheet - production data

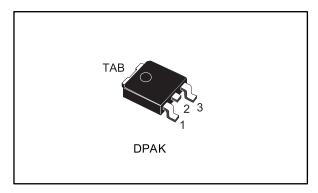
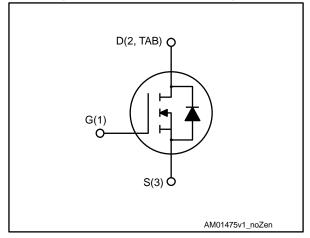


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	ΙD
STD60NF55LAT4	55 V	15 mΩ	60 A



- AEC-Q101 qualified
- Low threshold drive

Applications

Switching applications

Description

This Power MOSFET series realized with STMicroelectronics unique STripFET™ process is specifically designed to minimize input capacitance and gate charge. It is therefore ideal as a primary switch in advanced high-efficiency isolated DC-DC converters for Telecom and Computer applications. It is also suitable for any application with low gate charge drive requirements.

Table 1: Device summary

Order code	Marking	Package	Packing
STD60NF55LAT4	D60NF55LA	DPAK	Tape and reel

Contents STD60NF55LAT4

Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	DPAK (TO-252) type A2 package information	10
	4.2	DPAK (TO-252) packing information	13
5	Revisio	n history	15

STD60NF55LAT4 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	55	V
V_{GS}	Gate-source voltage	±15	V
	Drain current (continuous) at T _C = 25 °C	60	Δ
I _D	Drain current (continuous) at T _C = 100 °C	42	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	240	Α
Ртот	Total dissipation at T _C = 25 °C	110	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	16	V/ns
E _{AS} (3)	Single pulse avalanche energy	400	mJ
T _{stg}	Storage temperature range		°C
TJ	Operating junction temperature range	-55 to 175 °C	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.36	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	50	°C/W

Notes:

 $^{(1)}$ When mounted on a 1-inch² FR-4, 2 Oz copper board.

⁽¹⁾Pulse width is limited by safe operating area.

 $^{^{(2)}}I_{SD} \le 40A$, di/dt ≤ 350 A/ μ s, $V_{DD} \le V_{(BR)DSS}$, $T_J \le T_{JMAX}$

 $^{^{(3)}}Starting \, T_J = 25 \,\,^{\circ}C, \, I_D = 17.5 \,\, A, \, V_{DD} = 24 \,\, V$

Electrical characteristics STD60NF55LAT4

2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 4: Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	55			V
	Zara gata valtaga drain	$V_{GS} = 0 \text{ V}, V_{DS} = 55 \text{ V}$			1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 55 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$			10	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 15 \text{ V}$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		2	V
Static drain-source		$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$		12	15	mO.
R _{DS(on)}	on-resistance	V _{GS} = 5 V, I _D = 30 A		14	17	mΩ

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance			1950		
Coss	Output capacitance	$V_{DS} = 25 \text{ V}, f = 1 \text{ MHz},$	_	390	_	pF
Crss	Reverse transfer capacitance	Ves = 0 V		130		P.
Qg	Total gate charge	$V_{DD} = 40 \text{ V}, I_D = 60 \text{ A},$		40		
Q_{gs}	Gate-source charge	$V_{GS} = 0$ to 5 V, $R_G = 4.7 \Omega$ (see Figure 13: "Test circuit for	-	10	-	nC
Q_{gd}	Gate-drain charge	gate charge behavior")		20		

 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 25 \text{ V}, I_D = 30 \text{ A},$		30		
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 4.5 V$ (see Figure 12: "Test circuit for		180		
t _{d(off)}	Turn-off delay time	resistive load switching times"	-	80	-	ns
t _f	Fall time	and Figure 17: "Switching time waveform")		35		

Table 7: Source-drain diode

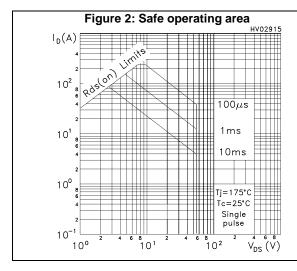
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		ı		60	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		ı		240	Α
V _{SD} ⁽²⁾	Forward on voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 60 \text{ A}$	ı		1.3	V
trr	Reverse recovery time	$I_{SD} = 40 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	ı	65		ns
Qrr	Reverse recovery charge	V _{DD} = 25 V, T _J = 150 °C (see <i>Figure 14: "Test circuit for</i>	-	130		nC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times"	1	4		А

Notes:

⁽¹⁾Pulse width is limited by safe operating area.

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

2.1 Electrical characteristics (curves)



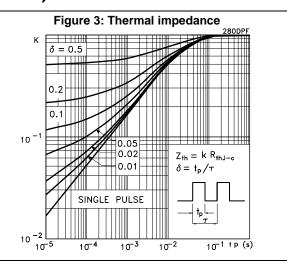


Figure 4: Output characteristics

HV02870

VGS=5V

150

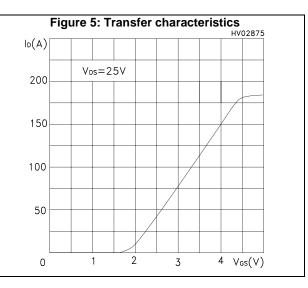
100

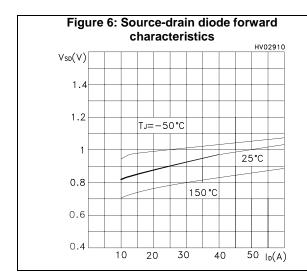
100

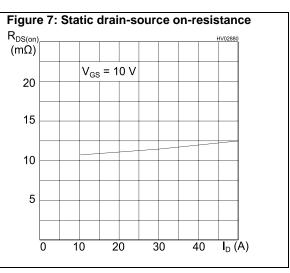
3V

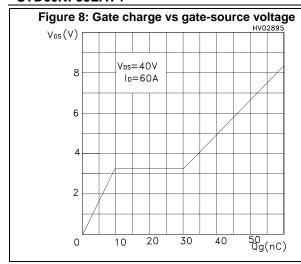
50

0 5 10 15 20 VDS(V)









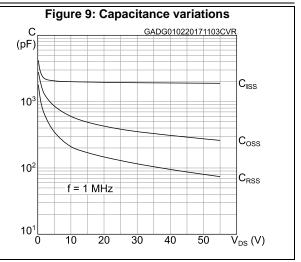
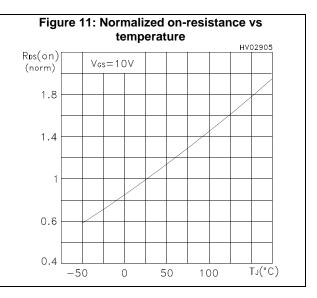


Figure 10: Normalized gate threshold voltage vs temperature HV02900 Vas(th) Vos=V gs Io = 250 pA (norm) 1.4 1.2 0.8 0.6 0.4 -50 0 50 100 150 T√℃>



Test circuits STD60NF55LAT4

3 Test circuits

Figure 12: Test circuit for resistive load switching times

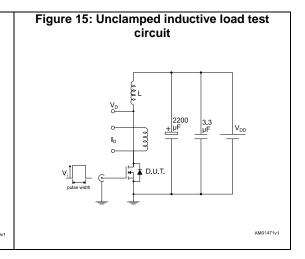
Figure 13: Test circuit for gate charge behavior

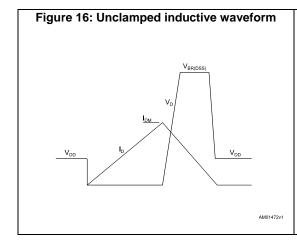
12 V 47 kΩ 100 nF D.U.T.

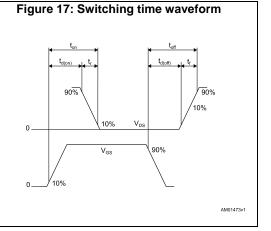
Vas pulse width 1 kΩ

Vas pulse width 1 kΩ

AM01468v1







4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 DPAK (TO-252) type A2 package information

Figure 18: DPAK (TO-252) type A2 package outline

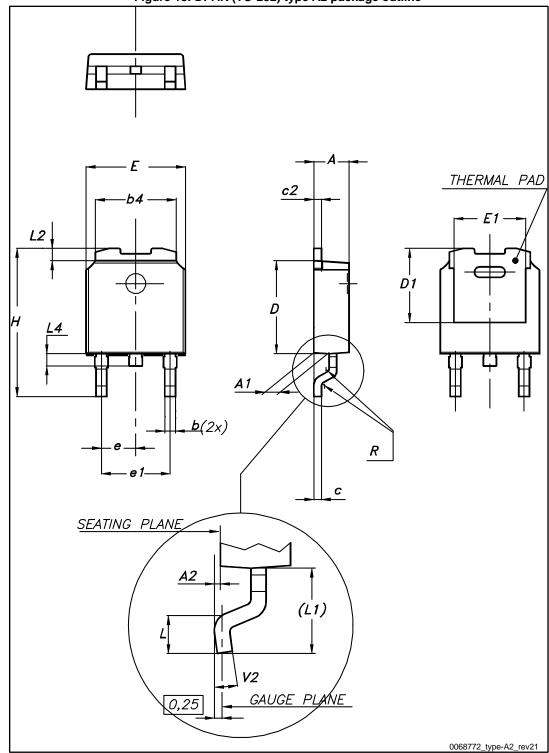


Table 8: DPAK (TO-252) type A2 mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
С	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1	4.95	5.10	5.25
E	6.40		6.60
E1	5.10	5.20	5.30
е	2.16	2.28	2.40
e1	4.40		4.60
Н	9.35		10.10
L	1.00		1.50
L1	2.60	2.80	3.00
L2	0.65	0.80	0.95
L4	0.60		1.00
R		0.20	
V2	0°		8°

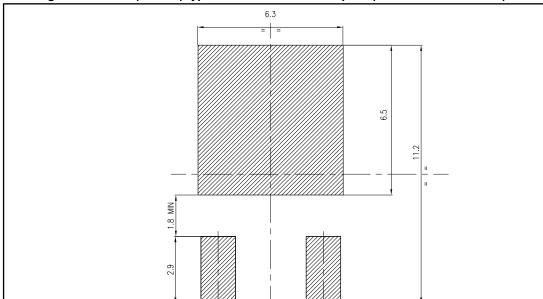
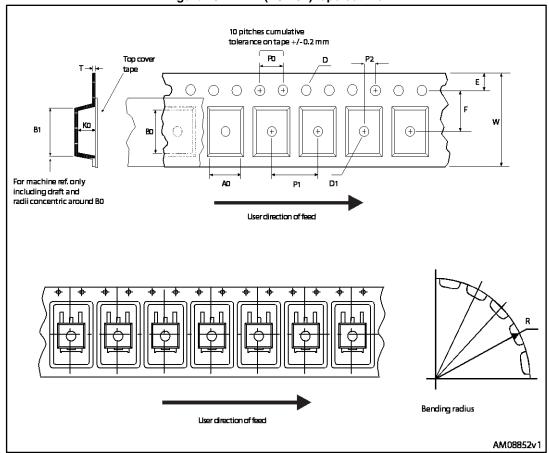


Figure 19: DPAK (TO-252) type A2 recommended footprint (dimensions are in mm)

FP_0068772_21

4.2 DPAK (TO-252) packing information

Figure 20: DPAK (TO-252) tape outline



40mm min. access hole at slot location С Ν G measured Tape slot at hub in core for Full radius tape start 2.5mm min.width

Figure 21: DPAK (TO-252) reel outline

Table 9: DPAK (TO-252) tape and reel mechanical data

AM06038v1

	Таре			Reel	
Dim.	n	mm		n	nm
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	6.8	7	Α		330
В0	10.4	10.6	В	1.5	
B1		12.1	С	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
Е	1.65	1.85	N	50	
F	7.4	7.6	Т		22.4
K0	2.55	2.75			
P0	3.9	4.1	Bas	se qty.	2500
P1	7.9	8.1	Bu	k qty.	2500
P2	1.9	2.1			
R	40				
Т	0.25	0.35			
W	15.7	16.3			

STD60NF55LAT4 Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
09-Feb-2017	1	First release

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

614233C 648584F IRFD120 JANTX2N5237 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L SBVS138LT1G 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C BUK954R8-60E NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 DMN2080UCB4-7 TK10A80W,S4X(S SSM6P69NU,LF DMP22D4UFO-7B DMN1006UCA6-7